MOSFET – Power, Single, P-Channel, UDFN, 2.0x2.0x0.55 mm -20 V, -8.2 A

Features

- UDFN Package with Exposed Drain Pads for Excellent Thermal Conduction
- Low Profile UDFN 2.0x2.0x0.55 mm for Board Space Saving
- Ultra Low R_{DS(on)}
- ESD Diode-Protected Gate
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Optimized for Power Management Applications for Portable Products, such as Cell Phones, Media Tablets, PMP, DSC, GPS, and Others
- Battery Switch
- High Side Load Switch

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Pa	Parameter			Value	Unit
Drain-to-Source Voltage			V _{DSS}	-20	V
Gate-to-Source Vol	tage		V _{GS}	±8.0	V
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	Ι _D	-8.2	А
Current (Note 1) Continuous Drain	Sidle	$T_A = 85^{\circ}C$		-5.9	
Current (Note 1)	t ≤ 5 s	$T_A = 25^{\circ}C$		-12.2	
Power Dissipa- tion (Note 1)	Steady State	$T_A = 25^{\circ}C$	PD	1.7	W
	t ≤ 5 s	T _A = 25°C	1	3.8	
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	I _D	-5.1	А
Current (Note 2)	State	$T_A = 85^{\circ}C$		-3.7	
Power Dissipation (Note 2)	$T_A = 25^{\circ}C$	PD	0.7	W
Pulsed Drain Curre	nt	tp = 10 μs	I _{DM}	-25	А
Operating Junction and Storage Temperature			T _J , T _{STG}	-55 to 150	°C
ESD (HBM, JESD22-A114)			V _{ESD}	2000	V
Source Current (Body Diode) (Note 2)			۱ _S	-1.7	А
Lead Temperature (1/8" from case for		g Purposes	ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface Mounted on FR4 Board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces).

 Surface-mounted on FR4 board using the minimum recommended pad size of 30 mm², 2 oz. Cu.

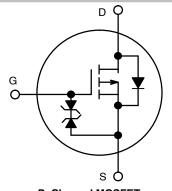


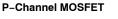
ON Semiconductor®

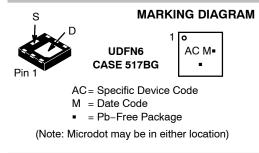
www.onsemi.com

MOSFET

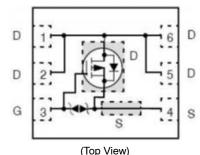
V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX				
	18 mΩ @ −4.5 V					
–20 V	25 mΩ @ –2.5 V	-8.2 A				
201	50 mΩ @ –1.8 V	0.271				
	90 mΩ @ –1.5 V					







PIN CONNECTIONS



ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient – Steady State (Note 3)	R _{θJA}	72	
Junction-to-Ambient – t \leq 5 s (Note 3)	R _{θJA}	33	°C/W
Junction-to-Ambient – Steady State min Pad (Note 4)	R_{\thetaJA}	189	

Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces).
Surface-mounted on FR4 board using the minimum recommended pad size of 30 mm², 2 oz. Cu.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Co	ndition	Min	Тур	Max	Units
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I	_D = –250 μA	-20			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	I _D = -250 μA	∧, ref to 25°C		+10		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = -20 V	$T_J = 25^{\circ}C$			-1.0	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V	/ _{GS} = ±5.0 V			±5	μA

ON CHARACTERISTICS (Note 5)

Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = -250 \ \mu A$	-0.4		-1.0	V
Negative Threshold Temp. Coefficient	V _{GS(TH)} /T _J			3.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$V_{GS} = -4.5$ V, $I_D = -7.0$ A		14.6	18	mΩ
		V_{GS} = -2.5 V, I _D = -5.0 A		19	25	
		$V_{GS} = -1.8$ V, $I_D = -3.0$ A		25	50	
		$V_{GS} = -1.5 \text{ V}, \text{ I}_{D} = -1.0 \text{ A}$		40	90	
Forward Transconductance	9 _{FS}	$V_{DS} = -5 \text{ V}, \text{ I}_{D} = -3.0 \text{ A}$		40		S

CHARGES, CAPACITANCES & GATE RESISTANCE

Input Capacitance	C _{ISS}		2240	pF
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = -15 V	240	
Reverse Transfer Capacitance	C _{RSS}		210	
Total Gate Charge	Q _{G(TOT)}		28	nC
Threshold Gate Charge	Q _{G(TH)}	$V_{GS} = -4.5 \text{ V}, V_{DS} = -15 \text{ V};$ $I_D = -4.0 \text{ A}$	1.0	
Gate-to-Source Charge	Q _{GS}	$I_{\rm D} = -4.0$ A	2.9	
Gate-to-Drain Charge	Q _{GD}		8.8	

SWITCHING CHARACTERISTICS, VGS = 4.5 V (Note 6)

Turn-On Delay Time	t _{d(ON)}		8.6	ns
Rise Time	t _r	V _{GS} = -4.5 V, V _{DD} = -15 V,	15	
Turn-Off Delay Time	t _{d(OFF)}	$\overline{I}_D = -4.0 \text{ A}, \ \overline{R}_G = 1 \Omega$	150	
Fall Time	t _f		88	

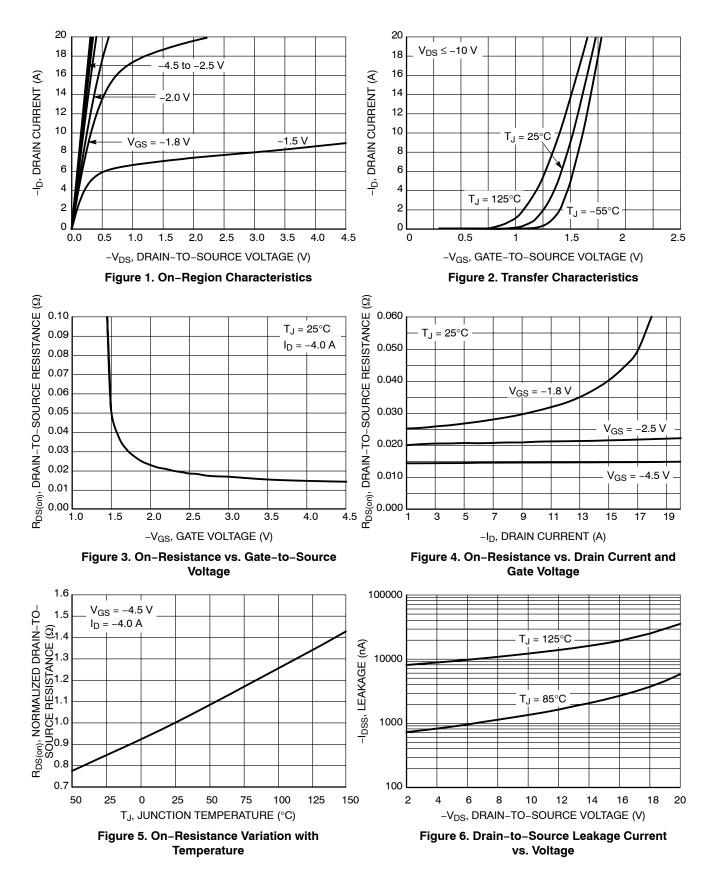
DRAIN-SOURCE DIODE CHARACTERISTICS

Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_{\rm J} = 25^{\circ}C$	0.63	1.0	V
		I _S = -1.0 A	T _J = 125°C	0.50		
Reverse Recovery Time	t _{RR}		_	26.1		ns
Charge Time	t _a	V_{GS} = 0 V, dls/dt = 100 A/µs, I _S = -1.0 A		10.2		
Discharge Time	t _b	I _S = -	-1.0 A	15.9		
Reverse Recovery Charge	Q _{RR}			12		nC

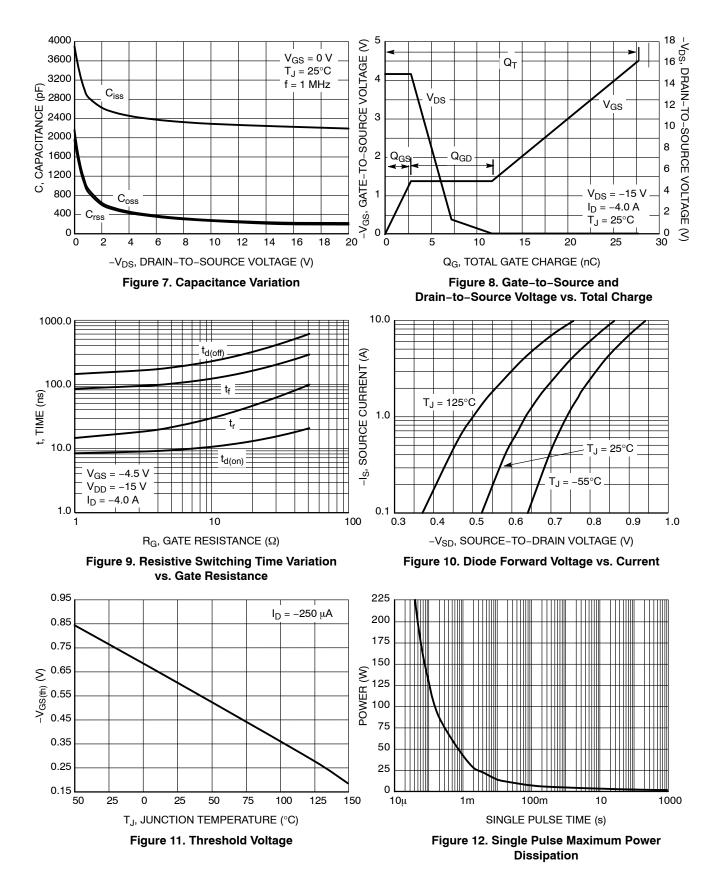
5. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%.

6. Switching characteristics are independent of operating junction temperatures.

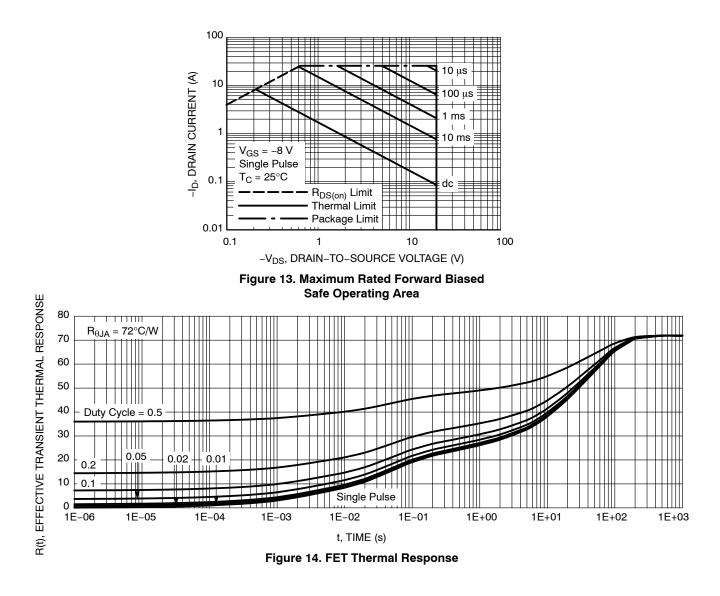
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

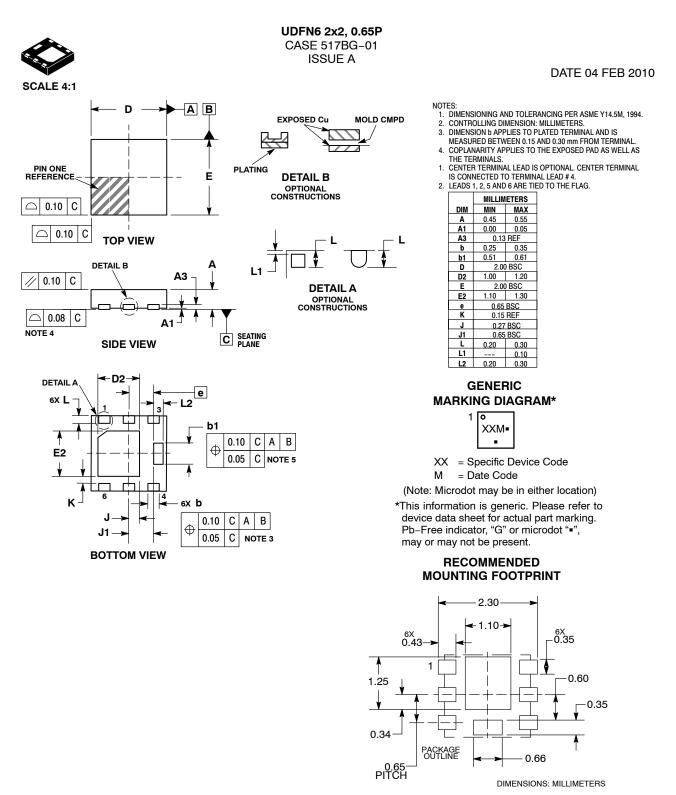


DEVICE ORDERING INFORMATION

Device	Package	Shipping [†]
NTLUS3A18PZTAG	UDFN6 (Pb-Free)	3000 / Tape & Reel
NTLUS3A18PZTBG	UDFN6 (Pb-Free)	3000 / Tape & Reel
NTLUS3A18PZTCG	UDFN6 (Pb–Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





DOCUMENT NUMBER:	98AON48158E	Electronic versions are uncontrolled except when accessed directly from the Document Report Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.				
DESCRIPTION:	UDFN6 2X2, 0.65P		PAGE 1 OF 1			

ON Semiconductor and unarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights or the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UF0-7B